

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number:

0524372571

Status:

Active

Overview:

Description:

0.50mm (.020") Pitch FFC/FPC Connector, Right Angle, SMT, ZIF, Bottom Contact Style, 25 Circuits, Gold Contact Plating

EU RoHS

ELV and RoHS

Compliant

REACH SVHC

Not Reviewed

Halogen-Free

Status

Not Reviewed

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

52437Series

Agency Certification

UL

E29179

General

Product Family

FFC/FPC Connectors

Series

52437

Overview

ffc_fpc_smt

Product Name

N/A

Physical

Circuits (Loaded)

25

Color - Resin

Natural

Contact Position

Bottom

Durability (mating cycles max)

20

Entry Angle

90° Angle

Flammability

94V-0

Material - Metal

Phosphor Bronze

Material - Plating Mating

Gold

Material - Plating Termination

Gold

Material - Resin

High Temperature Thermoplastic

Number of Rows

1

Orientation

Right Angle

PCB Locator

No

PCB Retention

None

Packaging Type

Embossed Tape on Reel

Pitch - Mating Interface (in)

0.020 In

Pitch - Mating Interface (mm)

0.50 mm

Plating min: Mating (µin)

4

Plating min: Mating (µm)

0.1

Plating min: Termination (µin)

2

Plating min: Termination (µm)

0.05

Polarized to PCB

Yes

Stackable

No

Surface Mount Compatible (SMC)

N/A

Temperature Range - Operating

-40°C to +85°C

Termination Interface: Style

Surface Mount

Wire/Cable Type

FFC/FPC

Electrical

Current - Maximum per Contact

0.5A

Voltage - Maximum

50V

Material Info

Reference - Drawing Numbers

Packaging Specification

SPK-52437-001

Product Specification

PS-52437-027, RPS-52437-040, RPS-52437-041, RPS-52437-042, RPS-52437-043, RPS-52437-045, RPS-52437-046

Sales Drawing

SD-52437-019, SD-52437-020

This document was generated on 06/04/2010

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

F

E

D

C

B

A

F

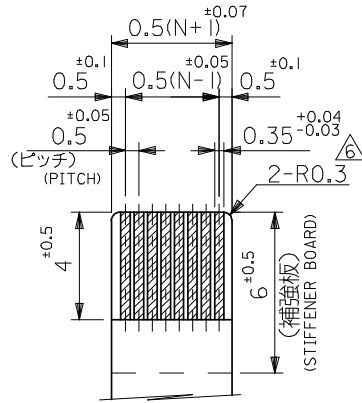
E

D

C

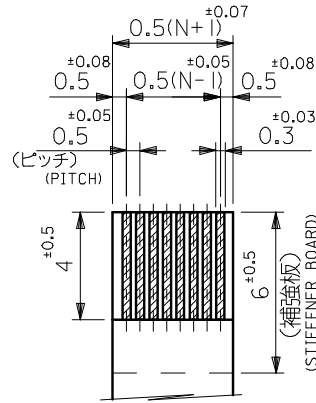
B

A



適合FPC推奨寸法
APPLICABLE FPC
RECOMMENDED DIMENSION.

(仕上がり厚さ: 0.3^{+0.05})
(THICKNESS: 0.3^{+0.05})



適合FFC推奨寸法
APPLICABLE FFC
RECOMMENDED DIMENSION.

(仕上がり厚さ: 0.3^{+0.05})
(THICKNESS: 0.3^{+0.05})

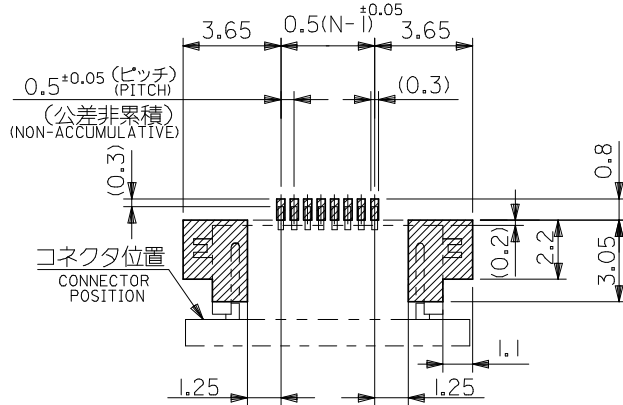
FPCについて:

打抜き方向は導体側から補強板側を推奨致します。
補強フィルム材質はポリイミドを推奨致します。
接着剤は熱硬化接着剤を推奨致します。

ABOUT FPC:

RECOMMENDED PUNCHER DIRECTION :
FROM CONDUCTOR SIDE TO STIFFENER BOARD SIDE.

RECOMMENDED MATERIAL:
STIFFENER FILM : POLYIMIDE
BONDING AGENT : THERMOSETTING BONDING AGENT



参考基板レイアウト
(マウント面)

RECOMMENDED P.C. BOARD
PATTERN DIMENSION (REF.)
(MOUNTING SIDE)

21.6	19.6	15.65	14.5	52437-3071	52437-3029	30
21.1	19.1	15.15	14.0	52437-2971	52437-2929	29
20.6	18.6	14.65	13.5	52437-2871	52437-2829	28
20.1	18.1	14.15	13.0	52437-2771	52437-2729	27
19.6	17.6	13.65	12.5	52437-2671	52437-2629	26
19.1	17.1	13.15	12.0	52437-2571	52437-2529	25
18.6	16.6	12.65	11.5	52437-2471	52437-2429	24
18.1	16.1	12.15	11.0	52437-2371	52437-2329	23
17.6	15.6	11.65	10.5	52437-2271	52437-2229	22
17.1	15.1	11.15	10.0	52437-2171	52437-2129	21
16.6	14.6	10.65	9.5	52437-2071	52437-2029	20
13.6	11.6	7.65	6.5	52437-1471	52437-1429	14
12.6	10.6	6.65	5.5	52437-1271	52437-1229	12
D	C	B	(A)	EMBOSSED TAPE	MATERIAL NO.	極数
				ORDER No. オーダー番号	MODEL NO. 52437-**-29	CKT.

REVISED EC NO: J2008-4048 2008/06/13 DRWN:WABEI 2008/06/16 CH'KD:THARUYAMA 2008/06/16 APPR:NUKITA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	±0.2	DRAWN BY M.UMEDA	DATE 2004/12/08	TITLE 0.5 FPC CONN.ZIF FOR SMT.RA (BOTTOM CONTACT) -LEAD FREE-				
		10 OVER 30 UNDER	±0.25	CHECKED BY K.TOYOTA	DATE 2004/12/08					
		30 OVER	±0.3	APPROVED BY N.UKITA	DATE 2004/12/08	MOLEX INCORPORATED				
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-52437-019		2 OF 2			
	REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								

F

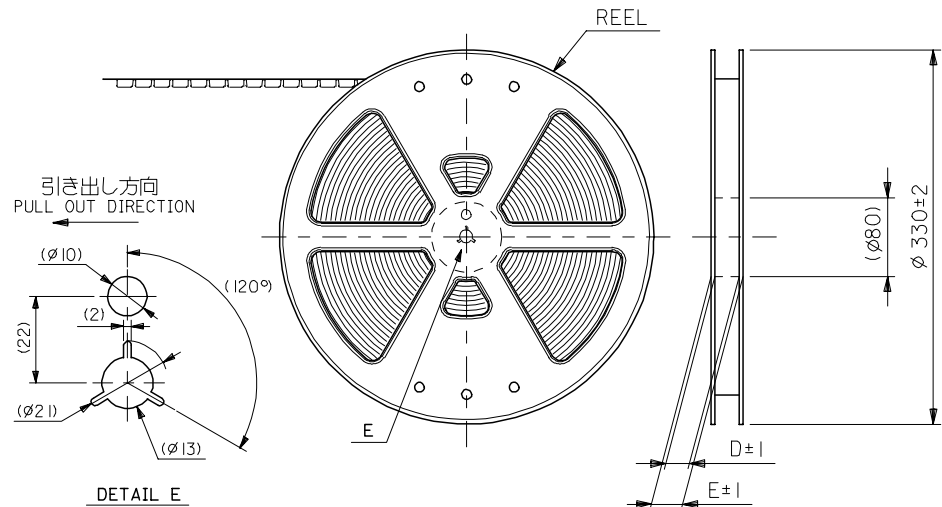
E

D

C

B

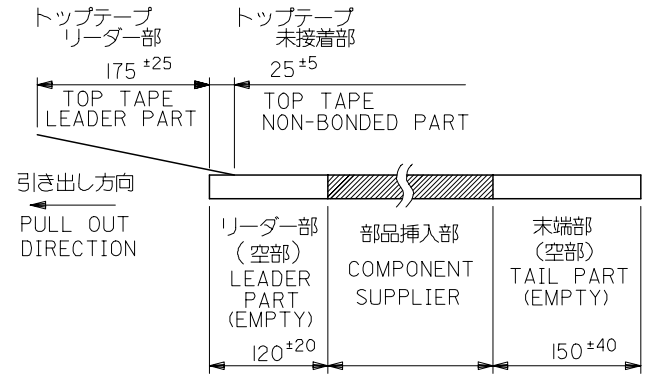
A



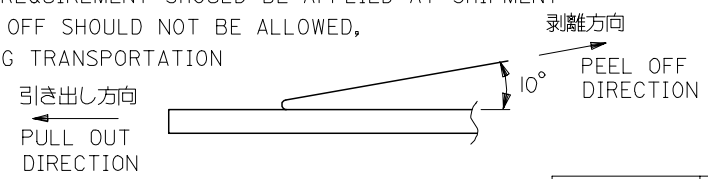
5. 材料 (MATERIAL)
キャリアテープ (CARRIER TAPE) : ポリプロピレン (POLYPROPYLENE)
トップテープ (TOPTAPE) : PET, PE, PEF
リール (REEL) : ポリスチレン (PS) <リサイクル材を含む>
POLYSTYREN (PS) <RECYCLE MATERIAL CONTAINED>
6. 本製品は 52437-***9I の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 52437-***9I.

注記 NOTES

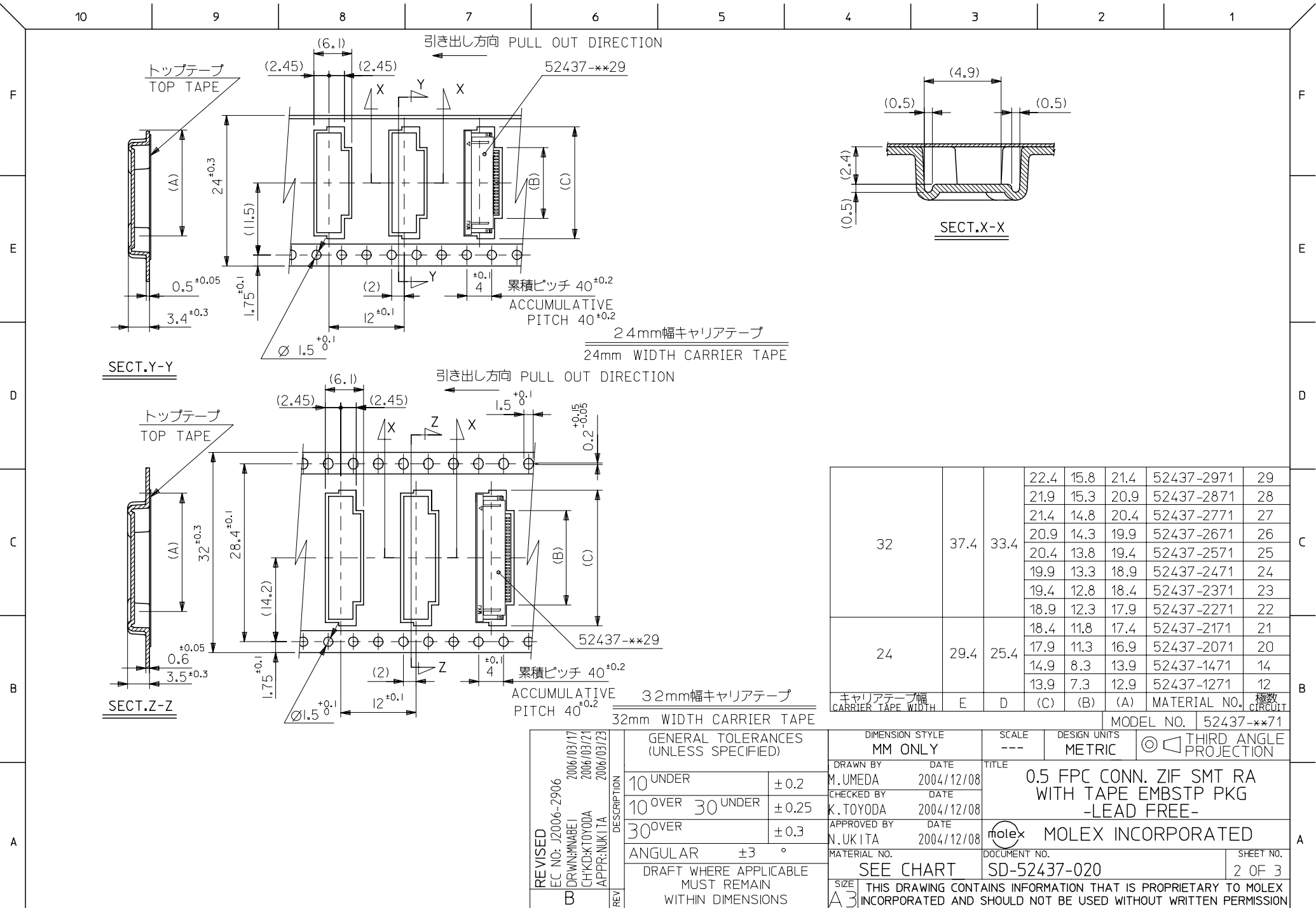
1. 製品番号52437-***29の梱包状態はアクチュエータがロックした状態とする。
製品の詳細寸法については図面SD-52437-019を参照下さい。
IN THE PACKAGE, ACTUATOR OF PART NO. 52437-***29 SHOULD BE LOCKED
RE DETAILED DIMENSIONS, SEE SD-52437-019.
2. 梱包数量 : 1000個/リール
NUMBER OF CONNECTORS: 1000PCS/REEL
3. リードテープ長さ LEAD TAPE LENGTH



4. トップテープの剥離強度 : (剥離方向は下図参照)
0. 1N ~ 1.3N {10gf ~ 130gf} 尚、本規格値は、出荷時に適用。
(但し、輸送時に剥離が発生しない事。)
PEELING OFF FORCE OF TOP TAPE
0. IN ~ 1.3N {10gf ~ 130gf} (PEELING DIRECTION AS SHOWN IN FOLLOWING FIG.)
THIS REQUIREMENT SHOULD BE APPLIED AT SHIPMENT
PEEL OFF SHOULD NOT BE ALLOWED,
DURING TRANSPORTATION



REVISED EC NO: J2006-2906 DRWN:MABE1 2006/03/17 CHKD:KTOYODA 2006/03/21 APPR:NUKITA 2006/03/23	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	MODEL NO. 52437-020		
				MM ONLY		---	METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	±0.2	DRAWN BY	DATE	TITLE 0.5 FPC CONN. ZIF SMT RA WITH TAPE EMBSTP PKG -LEAD FREE-				
		10 OVER 30 UNDER	±0.25	CHECKED BY	DATE					
		30 OVER	±0.3	APPROVED BY	DATE	MOLEX INCORPORATED				
		ANGULAR	±3 °	N. UKITA	2004-12/08					
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO.						
		SEE CHART		SD-52437-020		1 OF 3				
		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						





REVISED	EC NO: J2006-2906 DRAWN:MABEI CHK:KKT OYODA APPR:NUKITA	2006/03/17 2006/03/21 2006/03/21	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC		THIRD ANGLE PROJECTION
				10 UNDER	± 0.2	DRAWN BY M.UMEDA	DATE 2004/12/08	TITLE 0.5 FPC CONN. ZIF SMT RA WITH TAPE EMBSTP PKG -LEAD FREE-			
				10 OVER 30 UNDER	± 0.25	CHECKED BY K. TOYODA	DATE 2004/12/08				
				30 OVER	± 0.3	APPROVED BY N. UKITA	DATE 2004/12/08	 MOLEX INCORPORATED			
				ANGULAR ±3 °		MATERIAL NO.					
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-52437-020		3 OF 3	
			REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

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